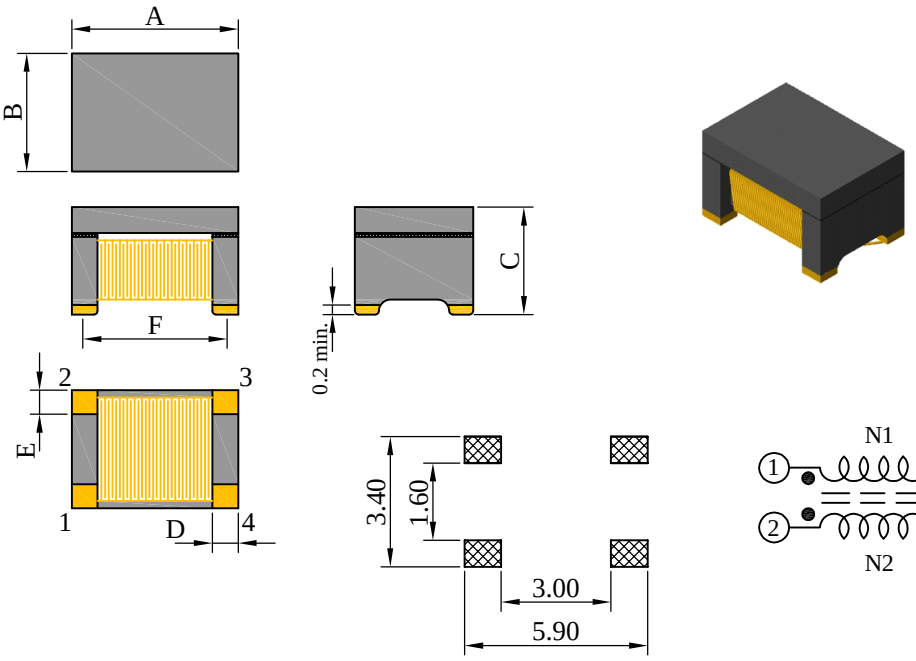
SPECIFICATION

PROD. NAME	SMD Common Mode Filter	PART NO.	SRF4530A SERIES		
		REF.:	REV.I(20160309)	PAGE	1

Ⅰ．Configuration and dimensions：



Unit：m/m

A	B	C	D	E	F
4.50 ±0.2	3.20 ±0.2	3.00 max.	0.70 ref.	0.65 ref.	3.80 ref.

Ⅱ．Description：

a．Ferrite drum core construction.

b．Magnetically shielded.

c．Enamelled copper wire：H class

d．Product weight：0.15 g（ref.）

e．Moisture sensitivity Level 1

f．Products comply with RoHS' requirements

g．Halogen Free available

Ⅲ．General specification：

a．Storage temp.：-55℃ ----+150℃

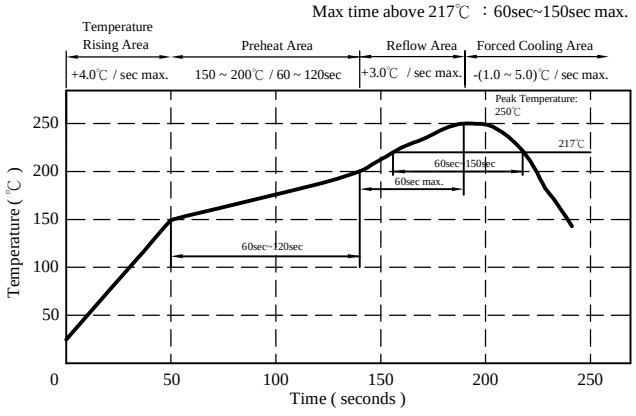
b．Operating temp.：-55℃----+150℃

（Temp. rise included）

c．Resistance to solder heat：250℃.10 secs.

d．Qualification to AEC-Q200 , available for automotive application on driver assistant、entertainment & lighting system.

Peak Temp：250℃ max.
Max. Peak Temp - 5℃：30sec max.
Max time above 217℃ ：60sec~150sec max.



BOURNS INDUCTIVE COMPONENTS

SPECIFICATION

PROD. NAME	SMD Common Mode Filter	PART NO.	SRF4530A SERIES		
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Ⅳ . Electrical characteristics：

PART NO.	Inductance (μH)	Lstray (μH) typ.	RDC (Ω) max.	IDC (A)	Common mode impedance (k Ω)(@10MHz) min.	typ.
SRF4530A-110Y	11.0 $^{+50\%}_{-30\%}$	0.10	0.50	0.36	0.30	0.60
SRF4530A-220Y	22.0 $^{+50\%}_{-30\%}$	0.15	0.60	0.31	0.60	1.20
SRF4530A-510Y	51.0 $^{+50\%}_{-30\%}$	0.25	1.00	0.23	1.50	3.50
SRF4530A-101Y	100.0 $^{+50\%}_{-30\%}$	0.30	1.50	0.20	3.00	7.50

1). Electrical specifications at 25℃
2). Inductance Test Condition.：100kHz / 0.1V
3). IDC base on Temp. rise 40℃ max.
4). Insulation resistance：10MΩ min.
5). Rated voltage：50Vdc

SPECIFICATION

PROD. NAME	SMD Common Mode Filter	PART NO.	SRF4530A SERIES		
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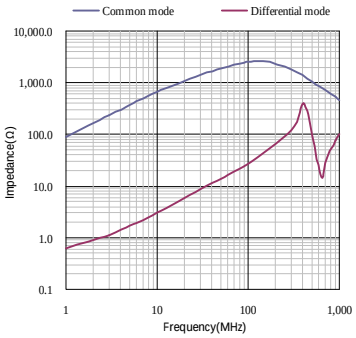
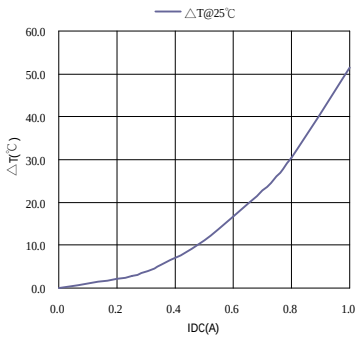
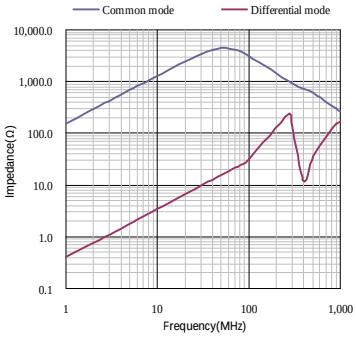
V . Curve：

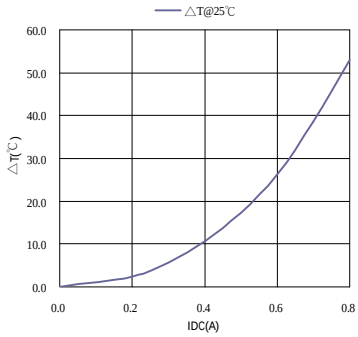
SRF4530A-110Y



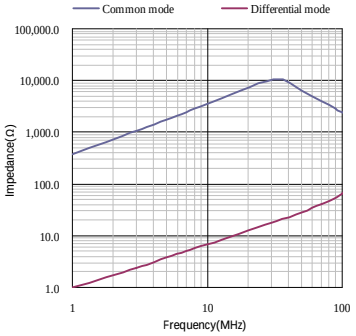


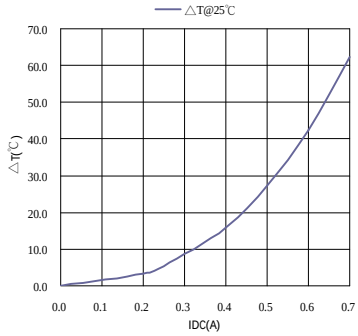
SRF4530A-220Y



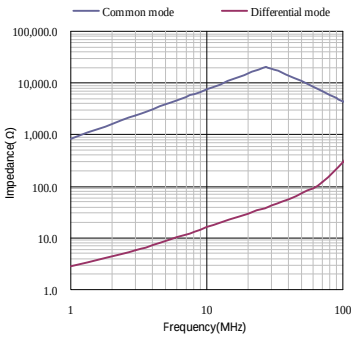


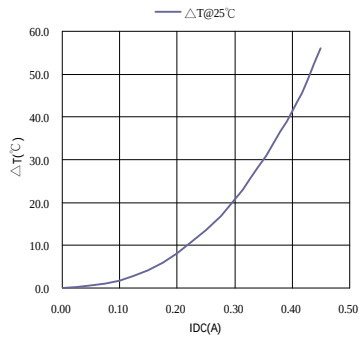
SRF4530A-510Y





SRF4530A-101Y





SPECIFICATION

PROD. NAME	SMD Common Mode Filter	PART NO.	SRF4530A SERIES		
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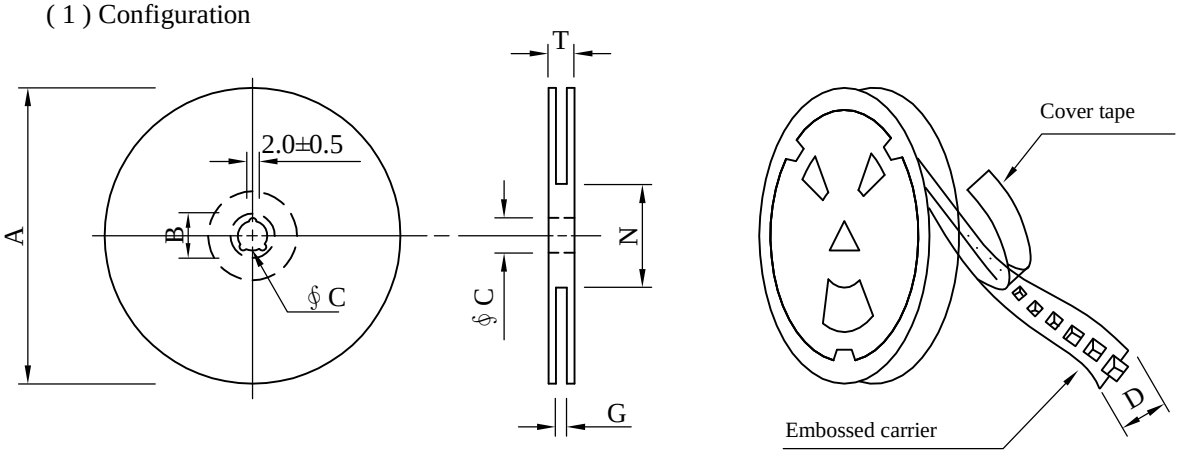
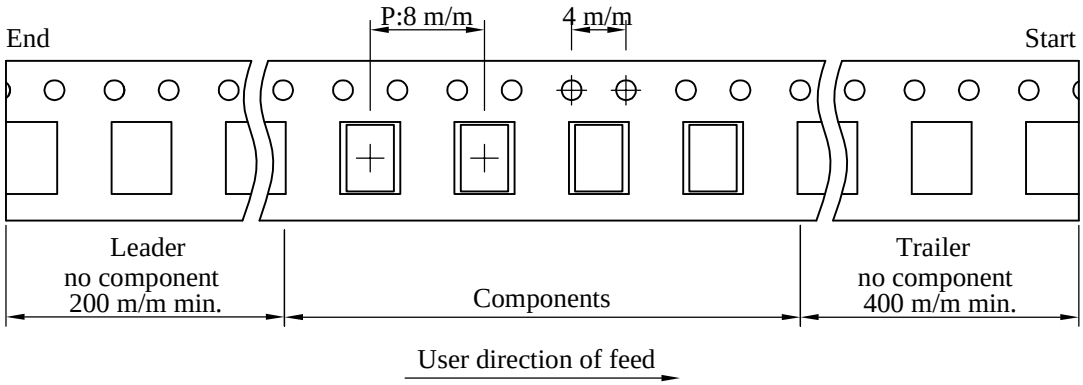
Ⅵ．Packaging information：

(1) Configuration



※Carrier tape width : D



(2) Dimensions

Unit:m/m

Style	A	B	C	D	G	N	T
07 - 12	178	21±0.8	13	12	14^{+0}	50^{-0}	16.5

(3) Q'TY & G.W. Pe package

Inner : Reel			Outer : Carton		
Q'TY (pcs)	G.W. (gw)	Style	Q'TY (pcs)	G.W. (kg)	Size (cm)
500	120	07 - 12	20,000	4.80	41 x 39 x 22

SPECIFICATION

PROD. NAME	SMD Common Mode Filter	PART NO.	SRF4530A SERIES		
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Ⅶ．Reliability test：

Item	Reference documents	AEC-Q200 Test Condition	Specification
1.High Temperature Exposure	MIL-STD-202 Method 108	1.Temperature: 150℃ 2.Time:1000 hours.	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±50%.
2.Temperature Cycling	JESD22 Method JA-104	1.Temperature: -55℃ ~ 150℃ 2.Number of cycle:1000 cycle 3.Dwell time:30 minutes	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±50%.
3.Biased Humidity Test	MIL-STD-202 Method 103	1.Temperature：85±5 ℃ 2.Time:1000 Hours 3.Humidity：85±5% RH.	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±50%.
4.Operational Life	MIL-PRF-27-3.26/4.7.23 & User Spec.	1.Temperature: 150℃ (Temp. rise included) 2.Time:1000 hours. 3.Apply rated current.	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±50%.
5.External Visual	MIL-STD-883 Method 2009	Inspect product constructions, marking and workmanship.	1.No pollution on the surface of products. 2.Clear marking. 3.No crack.
6.Physical Dimensions	JESD22 Method JB-100	Verify physical dimensions to the applicable product detail specification.	Per product specification standard
7.Resistance to solvents	MIL-STD-202 Method 215	Immerse into solvent for 3±0.5 minutes & brush 10 times for 3 cycles.	1.No body deformation change in appearance or obliteration of marking. 2.Inductance shall not change more than ±50%.
8.Mechanical Shock	MIL-STD-202 Method 213	1.Peak acceleration100g`s 2.Duration of pulse：6ms 3.Waveform：Half-sine 4.Velocity change：12.3ft/sec 5.Direction：±X, ±Y, ±Z (3times / axis)	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±50%.
9.Vibration Test	MIL-STD-202 Method 204	1.Frequency and Amplitued :10-2000-10 Hz 2.Sweep time：20 min 3.Acceleration：5g 4.Direction：X , Y , Z 5.Number of sweep：12 time/axis	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±50%.
10.Resistance To Soldering Heat Test	MIL-STD-202 Method 210 & J-STD020D.1	1.Highest temperature：250±5℃ 2.Time（temp.≧ 217℃）：60~150 second. 3.IR reflow times：3 times.	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±50%.
11.ESD	AEC-Q200-002 or ISO/DIS 10605	1.ESD Voltage：15KV 2.Mode 1：150 pF / 330 Ω 3.Mode 2：150 pF / 2000 Ω 4.Discharge times and polarity： 3 times pos. / 3 times eng. for each condition	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±50%.
12.Solderability Test	J-STD-002	1.Baking in pre-testing： 150±5℃ / 16Hours±30 min. 2.Peak temperature：240±5 3.Time（temp.≧217℃）：60~150 second. 4.IR reflow times：1 times.	More than 95% soldering coverage min on terminations.
13.Electrical Characteriazation	MIL-STD-202 Method 304 & User Spec.	1.Operating temperature：-55℃~150℃ 2.Room temperature：25℃.	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±50%.
14.Flammability			
15.Board Flex	AEC-Q200-005	1.Deflection speed：1 mm/ sec 2.Amount of deflection：2 mm 3.Span：90 mm 4.Direction for test：Bottom of PCB 5.Holding time : 60 sec	1.No mechanical or electrical damage. 2.Inductance shall not change more than ±50%.
16.Terminal Strength Test	AEC-Q200-006	1.Apply push force to samples mounted on PCB. 2.Force of 1.8 kg for 60±1 seconds.	After test, inductors shall be no mechanical damage.